LUMAWISE | Inverted Thru-Board Interconnects

TE Internal #: 2213189-3

Wire-to-Board, 2 Position, 3.3 mm [.12 in] Centerline, Printed Circuit

Board, Inverted Thru-Board Interconnects, Poke-In Connectors

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Connectors > Lighting Connectors > Poke-In Connectors











Connector System: Wire-to-Board

Number of Positions: 2

Centerline (Pitch): 3.3 mm [.12 in]

Connector & Contact Terminates To: Printed Circuit Board

Connector Height: 7.5 mm [.3 in]

Features

Product Type Features

Product Type Features	
Connector System	Wire-to-Board
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	2
Electrical Characteristics	
Operating Voltage	400 VDC
Body Features	
Primary Product Color	Natural
Contact Features	
	98.4 μin
Contact Mating Area Plating Material	Tin (Sn)
Contact Mating Area Plating Material Finish	Matte

3 A

Termination Features

Contact Current Rating (Max)



Termination Method to PCB	Surface Mount
Mechanical Attachment	
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	3.3 mm[.12 in]
Dimensions	
Connector Height	7.5 mm[.3 in]
Wire Size	22 – 18 AWG
Usage Conditions	
Operating Temperature Range	-40 – 130 °C[-40 – 266 °F]
Operation/Application	
Circuit Application	Power

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides

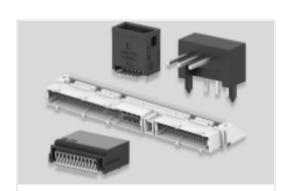


on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | Inverted Thru-Board Interconnects



PCB Headers & Receptacles(8)



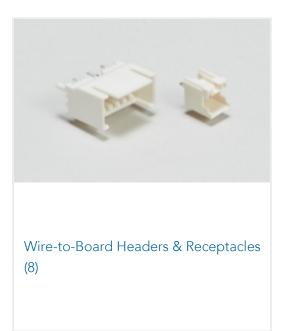
Poke-In Connectors(8)



Power Cable Assemblies(3)



Rectangular Power Connectors(3)



Customers Also Bought

















TE Part #2106431-2 Connector, SMT-IDC PASS THRU, 2 POS, 18





TE Part #2176110-1 3W SM M/OX 5% 12K STEEL LEADS

Documents

Product Drawings

Assembly, IPI Connector 22-18GA w cap

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2213189-3_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2213189-3_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2213189-3_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

Inverted Thru Board Interconnects

Inverted Thru Board Interconnects

English

Inverted Card Edge & Poke In Connector Brochure

English

Product Specifications

Application Specification

Wire-to-Board, 2 Position, 3.3 mm [.12 in] Centerline, Printed Circuit Board, Inverted Thru-Board Interconnects, Poke-In Connectors



English

Agency Approvals

Inverted Thru Board Connectors to IEC 60998

English

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English